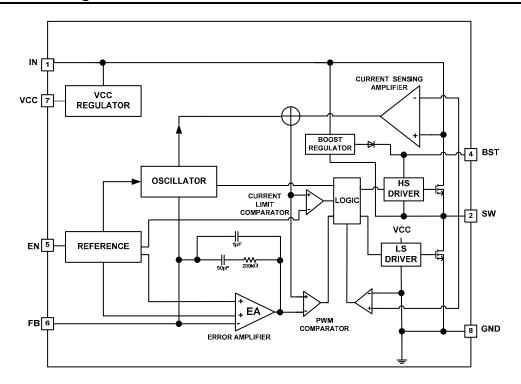


Pin Descriptions

Pin #	Name	Description		
1	IN	Supply Voltage. The AP6507 operates from a 4.5V to 18V input rail. C1 is needed to decouple the input rail. Use wide PCB trace to make the connection.		
2, 3	SW	Switch Output. Use wide PCB trace to make the connection.		
4	BST	Bootstrap. A capacitor connected between SW and BS pins is required to form a floating supply across the high-side switch driver.		
5	EN	EN=1 to enable the chip. For automatic start-up, connect EN pin to VIN by proper EN resistor divider as Figure 1 shows.		
6	FB	Feedback. An external resistor divider from the output to GND, tapped to the FB pin, sets the output voltage. To prevent current limit run away during a short circuit fault condition the frequency fold-back comparator lowers the oscillator frequency when the FB voltage is below 500mV.		
7	Vcc	BIAS Supply. Decouple with $0.1\mu F-0.22\mu F$ cap. The capacitance should be no more than $0.22\mu F$		
8	GND Exposed PAD	System Ground. This pin is the reference ground for the regulated output voltage. For this reason care must be taken in its PCB layout. Suggested to be connected to GND with copper and vias.		

Functional Block Diagram





Absolute Maximum Ratings (T_A = 25°C)

Symbol	Parameter	Rating	Unit		
V _{IN}	Supply Voltage	19	V		
V_{SW}	Switch Node Voltage	-0.3 to 20	V		
V_{BS}	Bootstrap Voltage	V _{SW} + 6	V		
V_{FB}	Feedback Voltage	-0.3 to +6	V		
V _{EN}	Enable/UVLO Voltage	-0.3 to +6	V		
V_{COMP}	Comp Voltage	-0.3 to +6	V		
T _{ST}	Storage Temperature	-65 to +150	°C		
TJ	Junction Temperature	+150	°C		
T_L	Lead Temperature	+260	°C		
ESD Susceptibility	ESD Susceptibility (Note 3)				
НВМ	Human Body Model	3	kV		
MM	Machine Model	300	V		

Thermal Resistance (Note 4)

Symbol	Parameter	Rating	Unit
θ_{JA}	Junction to Ambient	56	°C/W
$\theta_{ m JC}$	Junction to Case	16	°C/W

Recommended Operating Conditions (Note 5)

Symbol	Parameter	Min	Max	Unit
V_{IN}	Supply Voltage	4.5	18	V
T _A	Operating Ambient Temperature Range	-40	+85	°C

Notes:

- 2. Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 3. Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these device.
- 4. Test condition for SO-8EP: Device mounted on 2"*2" FR-4 substrate PC board, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.

 5. The device function is not guaranteed outside of the recommended operating conditions.



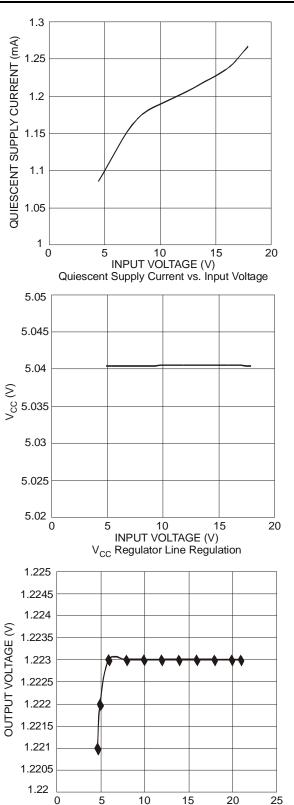
Electrical Characteristics (V_{IN} = 12V, T_A = +25°C, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit	
I _{IN}	Shutdown Supply Current	$V_{EN} = 0V$			15	μΑ	
I _{IN} Supply Current (Quiescent)		$V_{EN} = 2.0V, V_{FB} = 1.0V$		1.2		mA	
R _{DS(ON)1}	High-Side Switch On-Resistance (Note 6)			120		mΩ	
R _{DS(ON)2}	Low-Side Switch On-Resistance (Note 6)			20		mΩ	
SW _{LKG}	Switch Leakage Current	$V_{EN} = 0V$, $V_{SW} = 0V$		0	10	μΑ	
I _{Limit}	Current Limit			5.8		Α	
F _{SW}	Oscillator Frequency	V _{FB} = 0.75V	350	500	650	kHz	
F _{FB}	Fold-back Frequency	V _{FB} = 300mV		0.3		f_{SW}	
D _{MAX}	Maximum Duty Cycle	V _{FB} = 700mV	80	85		%	
V_{FB}	Feedback Voltage	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	788	808	828	mV	
I _{FB}	Feedback Current	V _{FB} = 800mV		10	50	nA	
V _{EN_Rising}	EN Rising Threshold		1.1	1.3	1.5	V	
V _{EN_HYS}	EN Threshold Hysteresis			0.4		V	
-	EN lancat Commant	$V_{EN} = 2V$		2		μΑ	
I _{EN}	EN Input Current	$V_{EN} = 0V$		0			
EN _{TD-Off}	EN Turn Off Delay (Note 6)			5		μs	
INUV _{Vth}	V _{IN} Under Voltage Threshold Rising		4.0	4.2	4.4	V	
INUV _{HYS}	V _{IN} Under Voltage Threshold Hysteresis			200		mV	
V _{CC}	VCC Regulator			5		V	
	VCC Load Regulation	Icc=5mA		5		%	
	Soft-Start Period			2		ms	
T_{SD}	Thermal Shutdown			140		°C	

Note: 6. Guaranteed by design

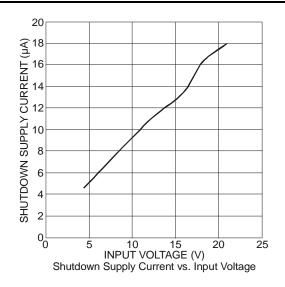


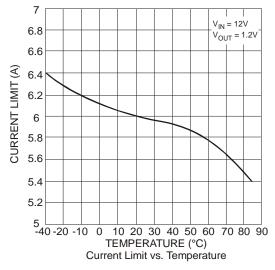
Typical Performance Graphs (V_{IN} = 12V, V_{OUT} = 1.2V, T_A = +25°C, unless otherwise noted

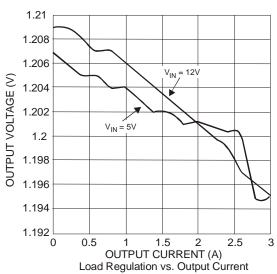


INPUT VOLTAGE (V)

Line Regulation vs. Output Current

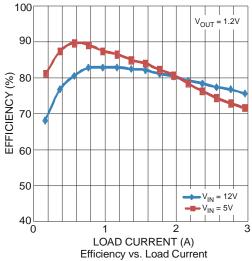


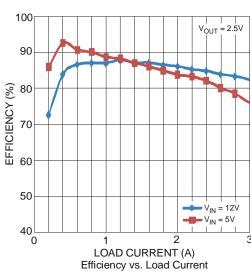


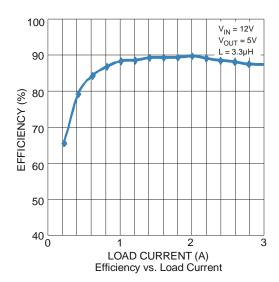


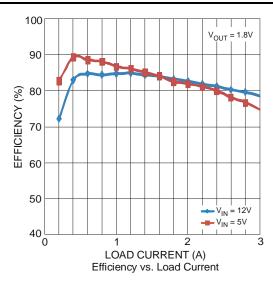


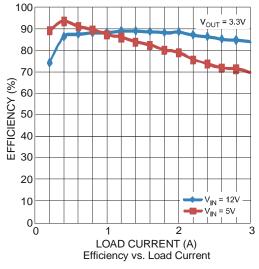
Typical Performance Graphs (cont.) (V_{IN} = 12V, V_{OUT} = 1.2V, T_A = +25°C, unless otherwise noted









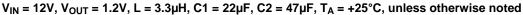


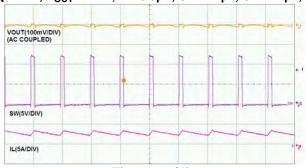
IL (5A/DIV)



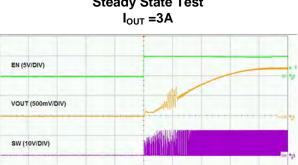
500 kHz 18V 3A SYNCHRONOUS DC/DC BUCK CONVERTER

Typical Performance Characteristics

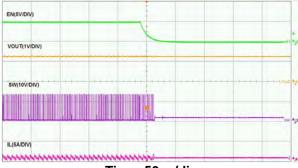




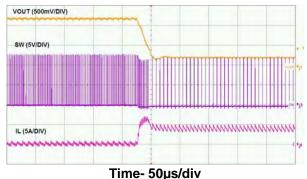
Time- 2µs/div Steady State Test I_{OUT} =3A



Time- 500us/div Start-up Through Enable (No Load)



Time- 50µs/div Shutdown Through Enable (No Load)



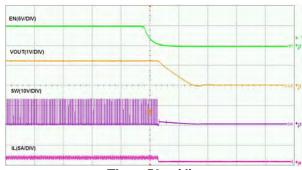
Short Circuit Entry



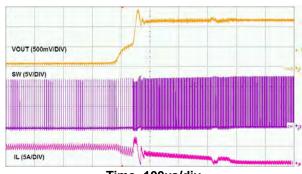
Time- 200μs/div Load Transient Test I_{OUT}=1.5A to 3A. Step at 0.8A/μs



 $\label{eq:time-2ms/div} \mbox{Start-up through V_{IN} (No load)}$



Time- 50µs/div Shutdown Through Enable (I_{OUT} =1A)

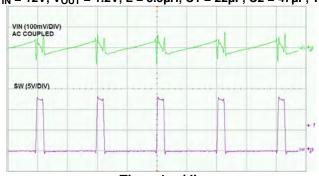


Time- 100µs/div Short Circuit Recovery

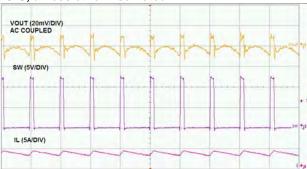


Typical Performance Characteristics

 V_{IN} = 12V, V_{OUT} = 1.2V, L = 3.3 μ H, C1 = 22 μ F, C2 = 47 μ F, T_A = +25°C, unless otherwise noted



Time- 1µs/div Input Voltage Ripple



Time- 2µs/div Output Voltage Ripple



Application Information

Theory of Operation

The AP6507 is a 3A current mode, synchronous buck regulator with built in power MOSFETs. Current mode control assures excellent line and load regulation and a wide loop bandwidth for fast response to load transients. Figure 4 depicts the functional block diagram of AP6507 is given on page 2.

The operation of one switching cycle can be explained as follows. At the beginning of each cycle, HS (high-side) MOSFET is off. The EA (error amplifier) output voltage is higher than the current sensing amplifier output, and the current comparator's output is low. The rising edge of the 500kHz oscillator clock signal sets the RS Flip-Flop. Its output turns on HS MOSFET. The current sensing amplifier is reset for every switching cycle.

When the HS MOSFET is on, inductor current starts to increase. The current sensing amplifier senses and amplifies the inductor current. Since the current mode control is subject to sub-harmonic oscillations that peak at half the switching frequency, slope compensation is utilized. This will help to stabilize the power supply. This slope compensation is summed to the current sensing amplifier output and compared to the error amplifier output by the PWM comparator. When the sum of the current sensing amplifier output and the slope compensation signal exceeds the EA output voltage, the RS Flip-Flop is reset and HS MOSFET is turned off.

For one whole cycle, if the sum of the current sensing amplifier output and the slope compensation signal does not exceed the EA output, then the falling edge of the oscillator clock resets the flip-flop. The output of the EA increases when feedback voltage (VFB) is lower than the reference voltage of 0.808V. This also increases the inductor current as it is proportional to the EA voltage.

When the HS MOSFET turns off, the synchronous LS MOSFET turns on until the next clock cycle begins. There is a "dead time" between the HS turn off and LS turn on that prevents the switches from "shooting through" from the input supply to ground.

The voltage loop is internally compensated with the 50pF and $200k\Omega$ RC network. The maximum EA voltage output is precisely clamped at 2.1V.

Internal Regulator

Most of the internal circuitry including the low-side driver is powered from the 5V internal regulator. When Vin is less than 5V, this internal regulator cannot maintain the 5V regulation and hence the output voltage would also drop from regulation.

Enable

The enable (EN) input allows the user to control turning on or off the converter. To enable the converter EN must be pulled above the 'EN Rising Threshold' and to disable the converter EN must be pulled below 'EN falling Threshold' (EN rising threshold — En threshold Hysteresis).

Few conditions on EN function:

- EN must be pulled low for at least 5us to disable the regulator.
- 2) The voltage on EN cannot exceed 5V.
- 3) The AP6507 can be enabled by Vin through a voltage divider as shown in the figure 3 below.

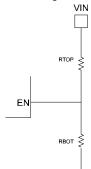


Figure 1. EN Divider Network

$$V_{IN-RISE} = V_{EN-RISE} \, \frac{(R_{TOP} + R_{BOT} \parallel \! 1 M \Omega}{R_{BOT} \parallel \! 1 M \Omega}$$

Where
$$V_{EN-RISE} = 1.3V(TYP)$$

$$V_{IN-FALL} = V_{EN-FALL} \, \frac{(R_{TOP} + R_{BOT} \, || \, 1M\Omega}{R_{BOT} \, || \, 1M\Omega} \label{eq:VIN-FALL}$$

Where
$$V_{EN-FALL} = 0.9V(TYP)$$

Internal Soft Start

Soft start is traditionally implemented to prevent an excess inrush current. This in turn prevents the converter output voltage from overshooting when it reaches regulation. The AP6507 has an internal current source with a soft start capacitor to ramp the reference voltage from 0V to 0.808V. The soft start time is internally fixed at 2ms (TYP). The soft start sequence is reset when there is a thermal shutdown, Under Voltage Lockout (UVLO) or when the part is disabled using the EN pin.



Application Information (cont.)

Current Limit Protection

In order to reduce the total power dissipation and to protect the application, AP6507 has cycle-by-cycle current limiting implementation. The voltage drop across the internal high-side MOSFET is sensed and compared with the internally set current limit threshold. This voltage drop is sensed at about 30ns after the HS turns on. This voltage drop is proportional to the peak inductor current. When the peak inductor current exceeds the set current limit threshold, current limit protection is activated. During this time the feedback voltage (VFB) drops down. When the voltage at the FB pin reaches 0.3V, the internal oscillator shifts the frequency from the normal operating frequency of 500kHz to a fold-back frequency of 150kHz. The current limit is reduced to 70% of nominal current limit when the part is operating at 150kHz. This low fold-back frequency prevents current runaway.

Under Voltage Lockout (UVLO)

Under Voltage Lockout is implemented to prevent the IC from operating under insufficient input voltages. The AP6507 has a UVLO comparator that monitors the input voltage and the internal bandgap reference. If the input voltage falls below 4.0V, the AP6507 will latch an under voltage fault. In this event the AP6507 will be disabled and power has to be re-cycled to reset the UVLO fault.

Thermal Shutdown

The AP6507 has on-chip thermal protection that prevents damage to the IC when the die temperature exceeds safe margins. It implements a thermal sensing to monitor the operating junction temperature of the IC. Once the die temperature rises to approximately 140°C, the thermal protection feature gets activated. The internal thermal sense circuitry turns the IC off thus preventing the power switch from damage.

A hysteresis in the thermal sense circuit allows the device to cool down to approximately 120°C before the IC is enabled again through soft start. This thermal hysteresis feature prevents undesirable oscillations of the thermal protection circuit.

Setting the Output Voltage

The output voltage can be adjusted from 0.808V to 15V using an external resistor divider. Table 1 shows a list of resistor selection for common output voltages. Resistor R1 is selected based on a design tradeoff between efficiency and output voltage accuracy. For high values of R1 there is less current consumption in the feedback network. However the trade off is output voltage accuracy

due to the bias current in the error amplifier. R2 can be determined by the following equation:

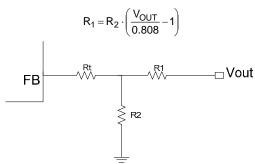


Figure 2. Feedback Divider Network

When output voltage is low, a T-type network as shown in Figure 2 is recommended.

V _{OUT} (V)	R ₁ (kΩ)	R ₂ (kΩ)	R _t (kΩ)
1.2	4.99	10.2	24.9
1.8	4.99 (1%)	4.02 (1%)	35.7
2.5	40.2 (1%)	19.1 (1%)	24.9
3.3	40.2 (1%)	13 (1%)	24.9
5	40.2 (1%)	7.68 (1%)	35.7

Table 1—Resistor Selection for Common Output Voltages

Inductor

Calculating the inductor value is a critical factor in designing a buck converter. For most designs, the following equation can be used to calculate the inductor value;

$$L = \frac{V_{OUT} \cdot (V_{IN} - V_{OUT})}{V_{IN} \cdot \Delta I_L \cdot f_{SW}}$$

Where $\Delta I_{\rm T}$ is the inductor ripple current.

And $f_{\scriptscriptstyle SW}$ is the buck converter switching frequency.

Choose the inductor ripple current to be 30% of the maximum load current. The maximum inductor peak current is calculated from:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_{L}}{2}$$



Application Information (cont.)

Inductor (cont.)

Peak current determines the required saturation current rating, which influences the size of the inductor. Saturating the inductor decreases the converter efficiency while increasing the temperatures of the inductor and the internal MOSFETs. Hence choosing an inductor with appropriate saturation current rating is important.

A 1 μ H to 10 μ H inductor with a DC current rating of at least 25% percent higher than the maximum load current is recommended for most applications. For highest efficiency, the inductor's DC resistance should be less than 200m Ω . Use a larger inductance for improved efficiency under light load conditions.

Input Capacitor

The input capacitor reduces the surge current drawn from the input supply and the switching noise from the device. The input capacitor has to sustain the ripple current produced during the on time on the upper MOSFET. It must hence have a low ESR to minimize the losses.

The RMS current rating of the input capacitor is a critical parameter that must be higher than the RMS input current. As a rule of thumb, select an input capacitor which has an RMS rating that is greater than half of the maximum load current.

Due to large dl/dt through the input capacitors, electrolytic or ceramics should be used. If a tantalum must be used, it must be surge protected. Otherwise, capacitor failure could occur. For most applications, a $4.7\mu F$ ceramic capacitor is sufficient.

Output Capacitor

The output capacitor keeps the output voltage ripple small, ensures feedback loop stability and reduces the overshoot of the output voltage. The output capacitor is a basic component for the fast response of the power supply. In fact, during load transient, for the first few microseconds it supplies the current to the load. The converter recognizes the load transient and sets the duty cycle to maximum, but the current slope is limited by the inductor value.

Maximum capacitance required can be calculated from the following equation:

$$C_{0} = \frac{L(I_{out} + \frac{\Delta I_{inductor}}{2})^{2}}{(\Delta V + V_{out})^{2} - V_{out}^{2}}$$

Where ΔV is the maximum output voltage overshoot.

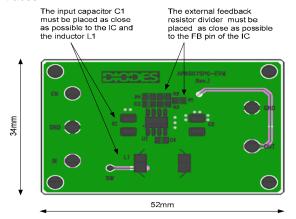
ESR of the output capacitor dominates the output voltage ripple. The amount of ripple can be calculated from the equation below:

$$Vout_{capacitor} = \Delta I_{inductor} * ESR$$

An output capacitor with ample capacitance and low ESR is the best option. For most applications, a 22µF ceramic capacitor will be sufficient.

PC Board Layout

This is a high switching frequency converter. Hence attention must be paid to the switching currents interference in the layout. Switching current from one power device to another can generate voltage transients across the impedances of the interconnecting bond wires and circuit traces. These interconnecting impedances should be minimized by using wide, short printed circuit traces.



AP6507 is exposed at the bottom of the package and must be soldered directly to a well designed thermal pad on the PCB. This will help to increase the power dissipation.

External Bootstrap Diode

It is recommended that an external bootstrap diode be added when the input voltage is lower than or equal to 5V and the duty cycle is greater than 65%. This external diode can be connected to the input or a 5V rail that is available in the system. This helps improve the efficiency of the converter. The bootstrap diode can be a low cost one such as BAT54 or a schottky that has a low Vf.

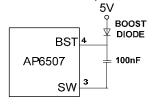
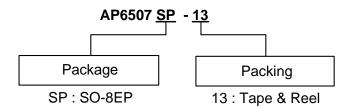


Figure 3. External Bootstrap Diode



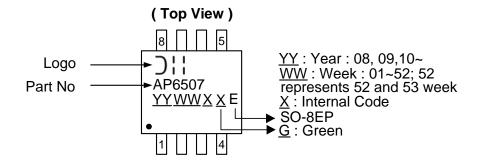
Ordering Information



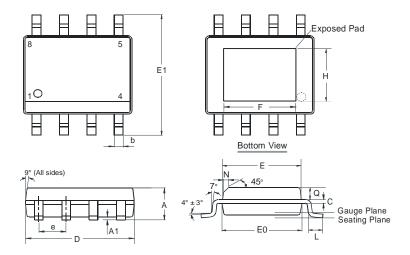
	Dovice	Package Packaging		13" Tape and Reel		
	Device	Code	(Note 7)	Quantity	Part Number Suffix	
Pb	AP6507SP-13	SP	SO-8EP	2500/Tape & Reel	-13	

Note: 7. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Marking Information



Package Outline Dimensions (All Dimensions in mm)



SO-8EP (SOP-8L-EP)					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.00	0.13	-		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
E1	5.90	6.10	6.00		
е	-	-	1.27		
F	2.75	3.35	3.05		
Н	2.11	2.71	2.41		
L	0.62	0.82	0.72		
N	-	-	0.35		
Q	0.60	0.70	0.65		
AII E	All Dimensions in mm				



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